



PATENT APPLICATION  
Docket No. 9903-078  
Client Ref. No. S02US013

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Young-Hee SONG, et al.

Serial No.: 10/651,813 Examiner: Williams, Alexander O.

Filed: August 28, 2003 Group Art Unit: 2826

Confirmation No.: 9556

For: SEMICONDUCTOR CHIP HAVING BOND PADS AND MULTI-CHIP PACKAGE

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Responsive to the Office Action dated January 27, 2005, enclosed is an amendment in the above-identified application.

The fee has been calculated as shown below.

CLAIMS AS AMENDED					
For:	Number After Amendment	Previous Number	Extra	Rate	Additional Fee
Total Claims	51	51	0	x \$50 =	\$0
Independent Claims	7	7	0	x \$200 =	\$0
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0

\*greater of twenty (20) or number for which fee has been paid

\*\*greater of three (3) or number for which fee has been paid

☒ Any deficiency or overpayment should be charged or credited to deposit account number 13-1703.

Customer No. 20575

Respectfully submitted,  
MARGER JOHNSON & McCOLLOM, P.C.

Hosoon Lee  
Reg. No. 56,737

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450  
Date: April 27, 2005

  
Hosoon Lee



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RESPONSE TO OFFICE ACTION

Responsive to the Office Action, Paper No. 20050122, dated January 27, 2005, please amend the application as follows.

**A Listing of the Claims** begins on page 2 of this paper.

**Remarks/Arguments** begin on page 10 of this paper.